

承 认 书

SPECIFICATION

蓝 晋 光 电	客 户 资 料
产品名称: LAMP LED	客 户:
产品型号: B302RUG9WCP/K	机 型:
规格描述: 3MM红翠绿双色共阴	日 期: 2016年9月28日

设 计:	日 期:
审 核:	
批 准:	承 办:

客 户 确 认	
签 名:	日 期:
结 论:	

Features

- P-LCC-3 package White package.
- White package.
- Optical indicator.
- Colorless clear window.
- Pb free.
- The product itself will remain within

Descriptions

- The 3mm series is available in soft orange, green, blue and yellow .
 Due to the package design, the LED has wideviewing angle and optimized light coupling by inter reflector. The low current requirement makes this device ideal for portable equipment or any other application

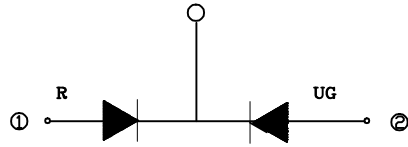
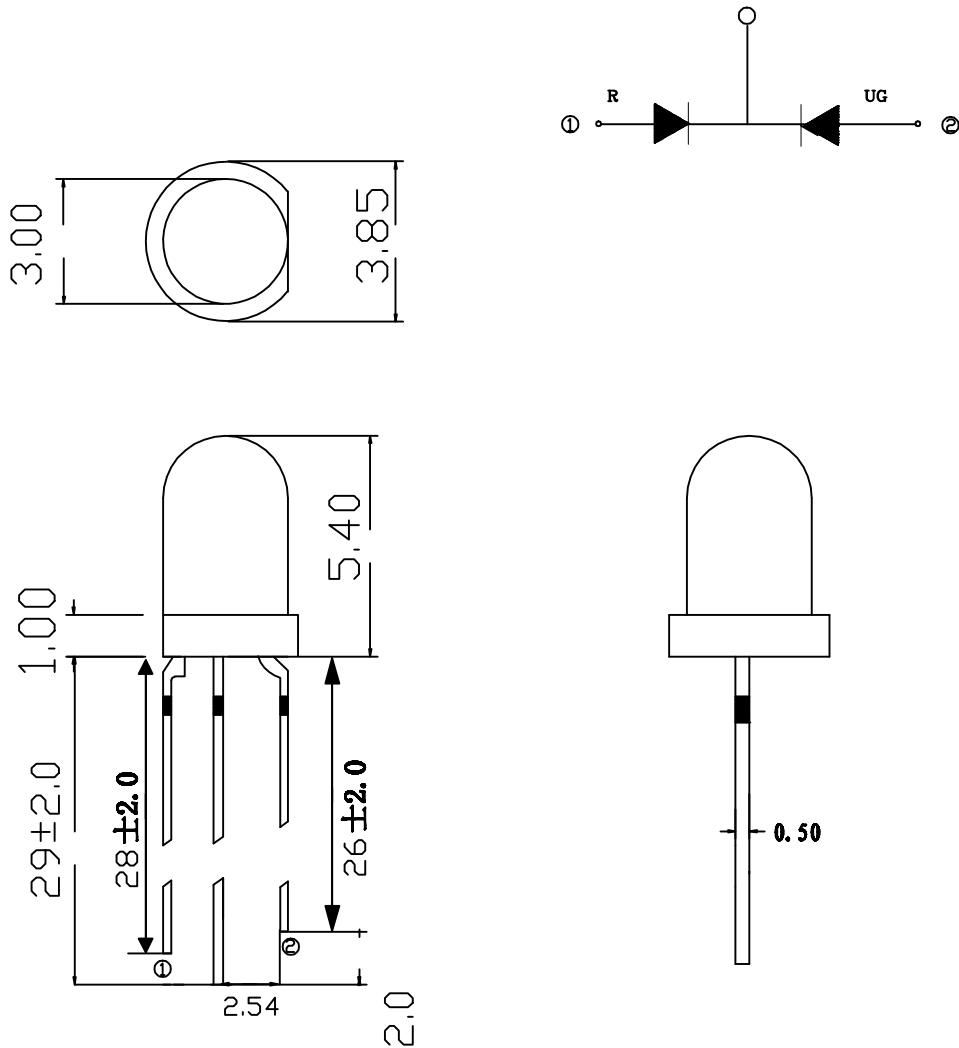
Applications

- Telecommunication, indicator and backlighting in telephone and fax.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

Device Selection Guide

Chip			Lens Color
Type	Material	Emitted Color	
B302RUG9WCP/K	GaInP	RED/GREEN	White Diffused

□ Package Outline Dimensions



Note: The tolerances unless mentioned is ±0.1mm; Unit=mm

□ Absolute Maximum Ratings($t_a=25^{\circ}\text{C}$)

ITEMS	SYMBOL	Rating		UNIT
Reverse Voltage	VR	5		V
Forward Current	If	R/UG	20	MA
Operation Temperature	Topt	-40~ +85		°C
Storage Temperature	Tstg	-40~ +100		°C
Electrostatic Discharge(HBM)	ESD	R/UG	2000	V
Power Dissipation	Pt	R	40	MW
		UG	60	
Peak Forward Current(Duty 1/10 @1KHZ)	IFP	R	50	MA
		UG	60	
Soldering Temperature	Tsol	Reflow Soldering :260°C for 10 sec Hand Soldering :300°C for 3 sec		

□ Absolute Maximum Ratings($t_a=25^{\circ}\text{C}$)

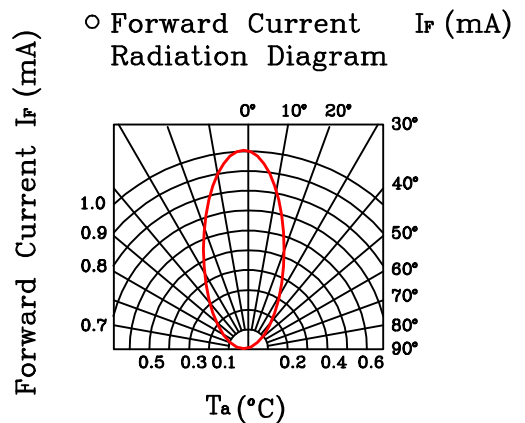
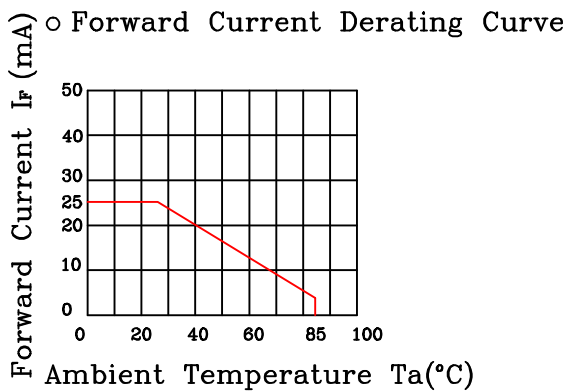
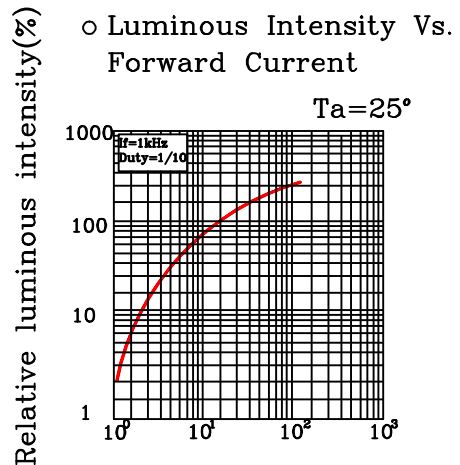
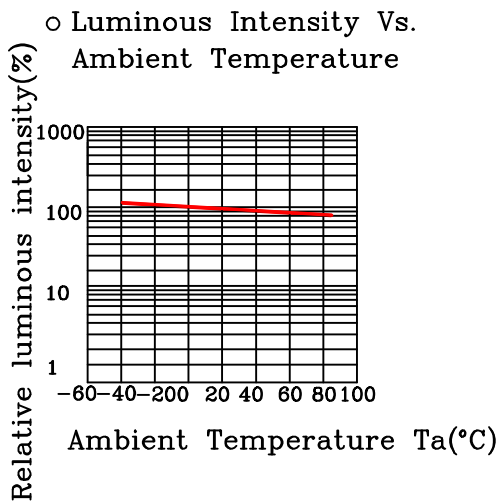
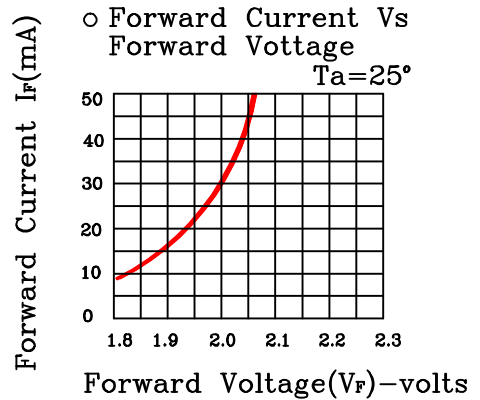
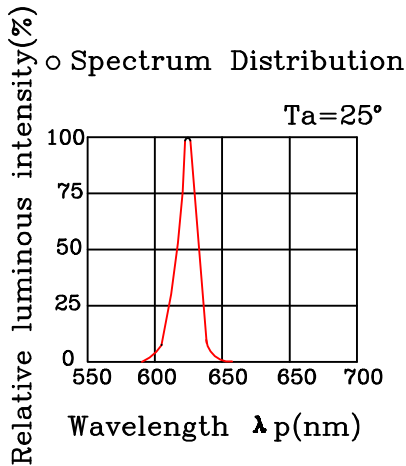
Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_v	R	***	350	***	mcd	IF=20mA
		UG	***	700	***		
Peak Wavelength	λ_P	R	***	625	***	nm	IF=20mA
		UG	***	522	***		
Dominant Wavelength	λ_d	R	620	***	630	nm	IF=20mA
		UG	518	***	525		
Spectrum Radiation Bandwidth	$\Delta \lambda$	R	***	20	***	nm	IF=20mA
		UG	***	3.3	***		
Forward Voltage	V_F	R	1.8	--	2.4	v	IF=20mA
		UG	2.8	--	3.4		
Viewing Angle	2 ϕ 1/2		—	60	—	deg	IF=20mA
Reverse Current	I_R	R	***	***	5	uA	VR=5v
		UG	***	***	5		

□*For each die

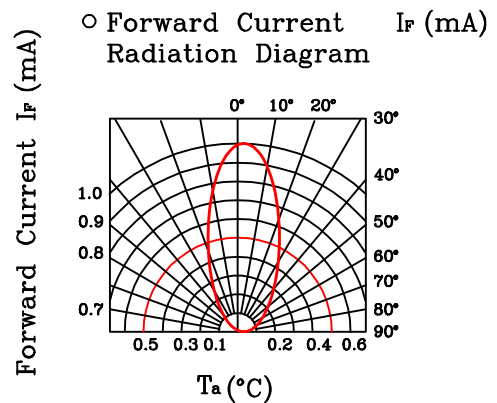
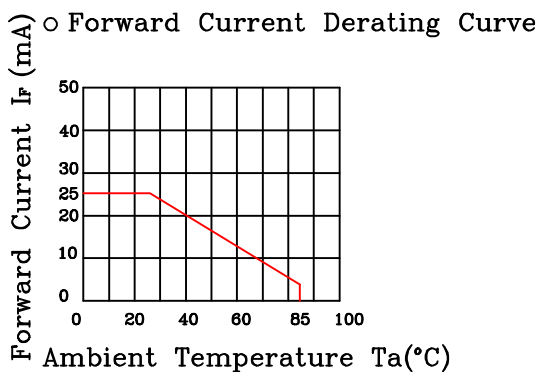
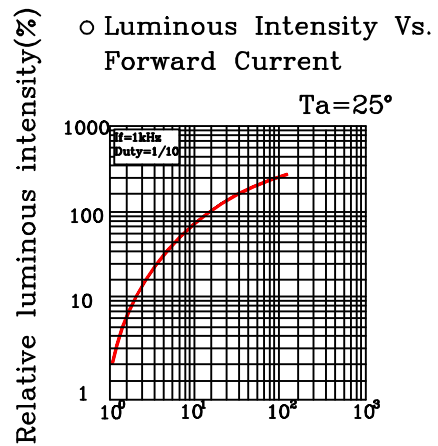
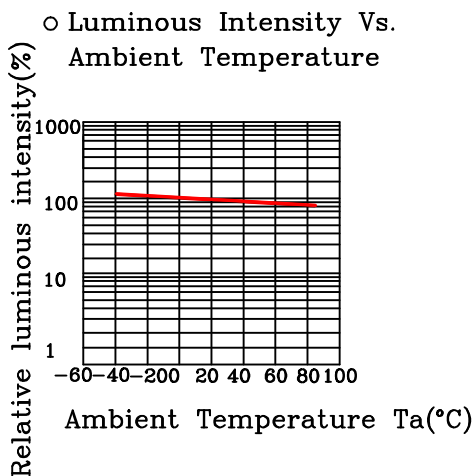
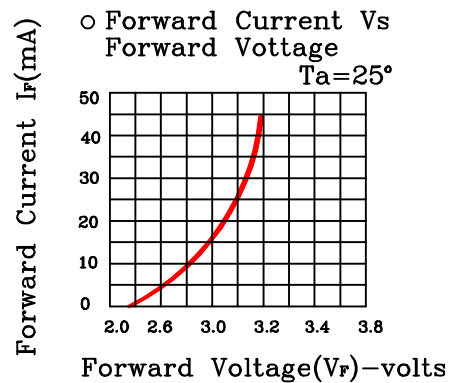
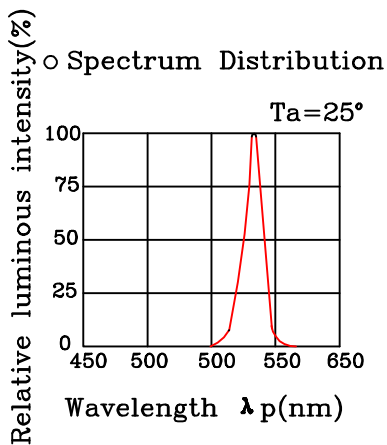
Notes:

- 1.Tolerance of Luminous Intensity $\pm 3\%$
- 2.Tolerance of Dominant Wavelength $\pm 1\text{nm}$
- 3.Tolerance of Forward Voltage $\pm 0.03\text{V}$

□ Typical Electrical–Optical Characteristics Curves(R)



□ Typical Electrical–Optical Characteristics Curves(UG)



The reliability of products shall be satisfied with items listed below.
 Confidence level:90%

LTPD:10%

NO	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp: 260±5°C	6min	22 PCS	0/1
2	Temperature Cycle	H:+100°C15min ∫ 5min L:-40°C15min	300 Cycles	22 PCS	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10sec L:-10°C 5min	300 Cycles	22 PCS	0/1
4	High Temperature Storage	Temp :100°C	1000 Hrs	22 PCS	0/1
5	LowTemperature Storage	Temp :-40°C	1000 Hrs	22 PCS	0/1
6	DC Operating Life	IF=20mA	1000 Hrs	22 PCS	0/1
7	High Temperature High Humidity	85°C/85%RH	1000 Hrs	22 PCS	0/1

□ Guideline for Soldering(1)

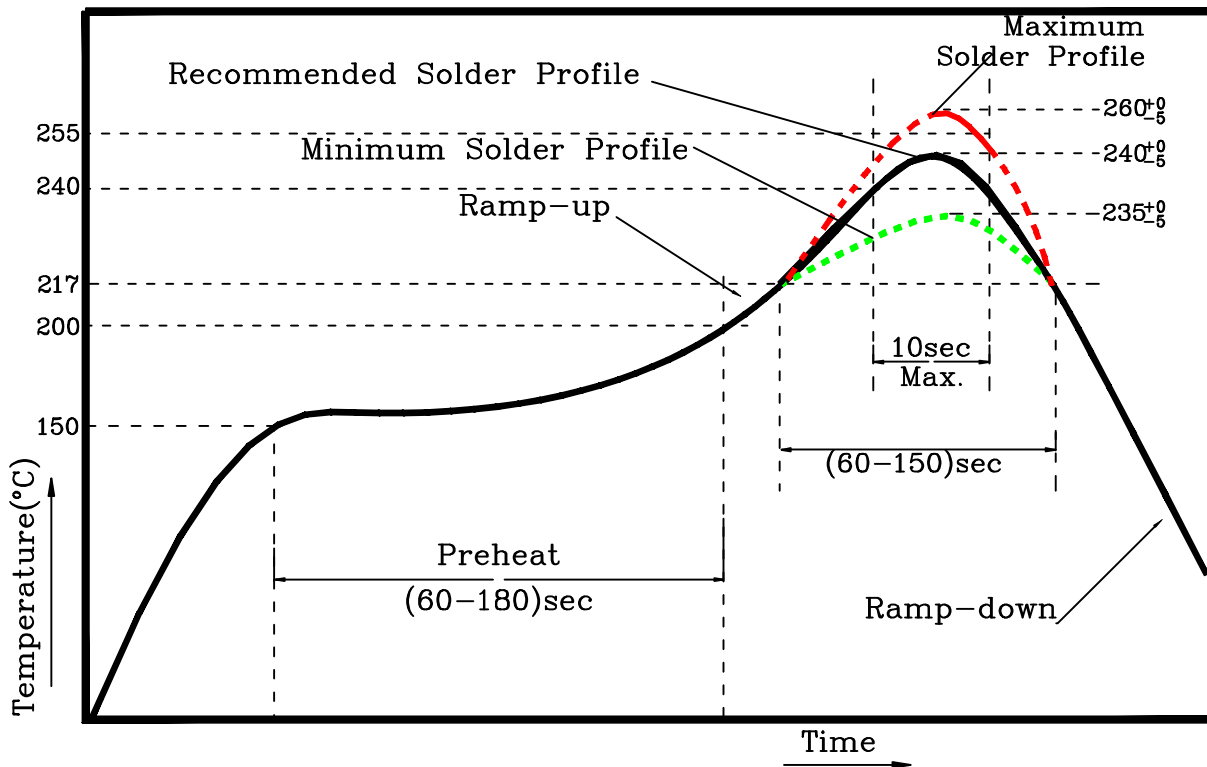
○ Hand Soldering

A soldering iron of less than 20W is recommended to be used in Hand Soldering. Please keep the temperature of the soldering iron under 300°C while soldering . Each terminal of the LED is to go for less than 3 second and for one time only.

Be careful because the damage of teh product is often started at teh time of the hand soldering .

○ Reflow Soldering

Use the conditions shown in the under Figure of Pb-Free Reflow Soldering.



- Reflow soldering should not be done more than two times .
- Stress on the LEDs should be avoided during heating in soldering process
- After soldering, do not deal with the product before its temperature drop down to room temperature.

□Precautions(1)

○ Storage

Moisture proof and anti- electrostatic package with moisture absorbent material is used , to keep moisture to a minimum

Before opening the package,the product should be kept at 30°C or less and humidity less than 60%Rh,and be used within a year.

Afer opening the package,the product should be stoted at 30 or less and humidity less than 10%RH,and be soldered within 24 hours.It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH

If the moisture absorbent material has fade away or the LEDS have exceeded the storage time,baking treatment.should be performed based on the following condition:(60±5C) for 12 hours.

○ Static Electricity

Static electricity or surge voltage damages the LEDs . Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current . even not lihgt

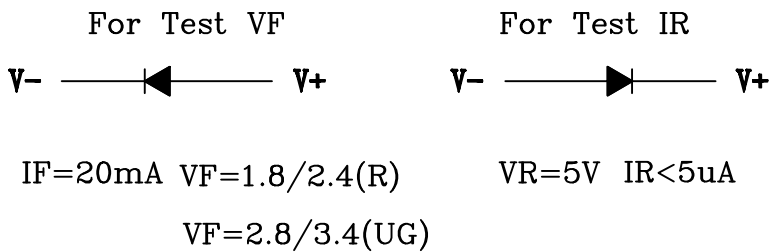
All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves,anti-electrostatic containers be used when dealing with the LEDs.

Precautions(2)

◦ Design Consideration

In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED . In the meanwhile,resistors for protection should be applied,otherwise slight voltage shift will cause big current change,burn out may happen.

It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B. in forward V oltage (Vf) of the LEDs.In the worst case ,some LED may be subjected to stresses in excess of the Absolute Maximum Rating



◦ Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Colr changed and so on.Please consider the htat generation of the LEDs when making the system design.